



## **DCR2290V65**

# **Phase Control Thyristor**

Replaces DS6073-2 DS6073-3 August 2022 (LN41979)

#### **FEATURES**

- Double Side Cooling
- High Surge Capability

#### **APPLICATIONS**

- High Power Drives
- High Voltage Power Supplies
- Static Switches

## **VOLTAGE RATINGS**

Part and Ordering Number	Repetitive Peak Voltages VDRM and VRRM (V)	Conditions
DCR2290V65* DCR2290V60 DCR2290V55	6500 6000 5500	Tvj = -40°C to 125°C, IDRM = IRRM = 300mA, VDRM, VRRM tp = 10ms VDSM & VRSM = VDRM & VRRM + 100V respectively

Lower voltage grades available.

## **ORDERING INFORMATION**

When ordering, select the required part number shown in the Voltage Ratings selection table.

For example:

#### DCR2290V55

Note: Please use the complete part number when ordering and quote this number in any future correspondence relating to your order.

#### **KEY PARAMETERS**

$\mathbf{V}_{DRM}$	6500V
IT(AV)	2280A
Ітѕм	30000A
dV/dt*	1500V/μs
dI/dt	500A/μs

<sup>\*</sup> Higher dV/dt selections are available on request

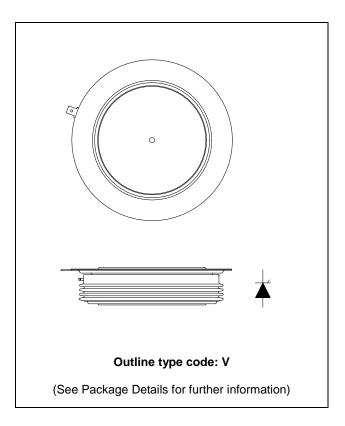


Fig. 1 Package outline

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<sup>\*6200</sup>V @ -40°C, 6500V @ 0°C



## **CURRENT RATINGS**

## T<sub>case</sub> = 60°C unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units
Double Si	de Cooled			
IT(AV)	Mean on-state current	Half wave resistive load	2280	А
IT(RMS)	RMS value	-	3580	Α
lτ	Continuous (direct) on-state current	-	3510	А

## **SURGE RATINGS**

Symbol	Parameter	Test Conditions	Max.	Units
Ітѕм	Surge (non-repetitive) on-state current	10ms half sine, T <sub>case</sub> = 125°C	30.0	kA
l²t	I2t for fusing	V <sub>R</sub> = 0	4.50	MA <sup>2</sup> s

## THERMAL AND MECHANICAL RATINGS

Symbol	Parameter	Test Conditions		Min.	Max.	Units
		Double side cooled	DC	-	7.5	°C/kW
Rth(j-c)	Rth(j-c) Thermal resistance - junction to case	Single side cooled	Anode DC	-	13.0	°C/kW
			Cathode DC	-	17.8	°C/kW
<b>D</b>	Clamping f	Clamping force 54kN	Double side	-	2.0	°C/kW
Rth(c-h)	Thermal resistance - case to heatsink	(with mounting compound)	Single side	-	4.0	°C/kW
Tvj	Virtual junction temperature	Blocking VDRM / VRRM		-	125	°C
Tstg	Storage temperature range			-55	125	°C
Fm	Clamping force			48	59	kN

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# **DYNAMIC CHARACTERISTICS**

Symbol	Parameter	Test Condition	ns	Min.	Max.	Units
IRRM/IDRM	Peak reverse and off-state current	At VRRM/VDRM, Tcase = 125°C	;	-	300	mA
Vтм	Instantaneous forward voltage	At 4000A peak, Tj = 125°C		2.30	2.65	V
dV/dt	Max. linear rate of rise of off-state voltage	To 67% V <sub>DRM</sub> , T <sub>j</sub> = 125°C, g	ate open	-	1500	V/µs
dl/dt	Rate of rise of on-state current	From 67% V <sub>DRM</sub> to 2x I <sub>T(AV)</sub> Gate source 30V, 10Ω	Repetitive 50Hz	-	150	A/µs
di/dt	reate of fise of on-state current	tr < 0.5µs, Tj = 125°C	Non-repetitive	-	500	A/µs
V	Threshold voltage - Low level	500A to 2600A at Tcase = 125°C		-	1.01	V
<b>V</b> T(TO)	Threshold voltage - High level	2600A to 7000A at Tcase = 125°C		-	1.24	V
	On-state slope resistance - low level	500A to 2600A at Tcase = 125°C		-	0.44	mΩ
ľτ	On-state slope resistance - High level	2600A to 7000A at Tcase = 125°C		-	0.35	mΩ
tgd	Delay time	$V_D$ = 67% $V_{DRM}$ , gate source 30V, 10Ω $t_T$ = 0.5 $\mu$ s, $T_j$ = 25°C		-	3	μs
tq	Turn-off time	Tj = 125°C, V <sub>R</sub> = 200V, dl/dt = 1A/μs, dV <sub>DR</sub> /dt = 20V/μs linear		-	1200	μs
Qs	Stored charge	T <sub>j</sub> = 125°C, dI/dt = 1A/μs VR(peak) ~ 3900V, VRM ~ 2600V		2790	5920	μC
IRR	Reverse recovery current			40	58	А
lι	Latching current	Tj = 25°C, VD = 5V		-	3	Α
Ін	Holding current	T <sub>j</sub> = 25°C, R <sub>G</sub> -κ = ∞, I <sub>TM</sub> = 500A, I <sub>T</sub> = 5A		-	300	mA

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## **GATE TRIGGER CHARACTERISTICS AND RATINGS**

Symbol	Parameter	Test Conditions	Max.	Units
<b>V</b> GT	Gate trigger voltage	VDRM = 5V, Tcase = 25°C	1.5	V
<b>V</b> GD	Gate non-trigger voltage	At 50% VDRM, Tcase = 125°C	0.4	V
Ідт	Gate trigger current	VDRM = 5V, Tcase = 25°C	400	mA
lgp	Gate non-trigger current	At 50% VDRM, Tcase = 125°C	15	mA

## **CURVES**

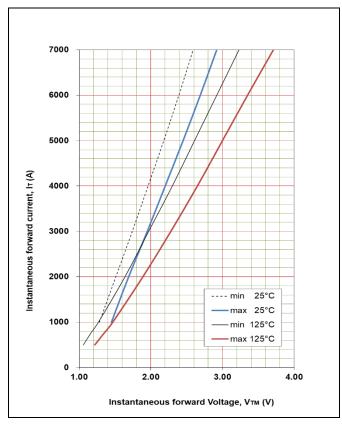


Fig. 2 Maximum & minimum on state characteristics

## **VTM EQUATION**

 $V_{TM} = A + B.ln(I_T) + C.I_T + D.\sqrt{I_T}$ 

Where A = 0.537656

B = 0.064223

C = 0.000301

D = 0.005935

These values are valid for  $T_j = 125^{\circ}C$  for  $I_{T}$  500A to 7000A

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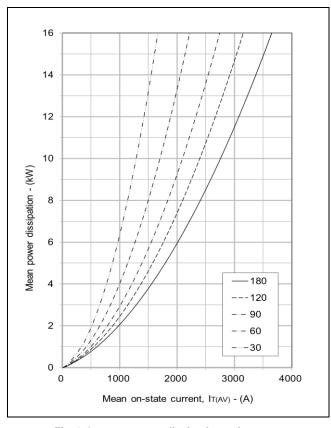


Fig. 3 On-state power dissipation - sine wave

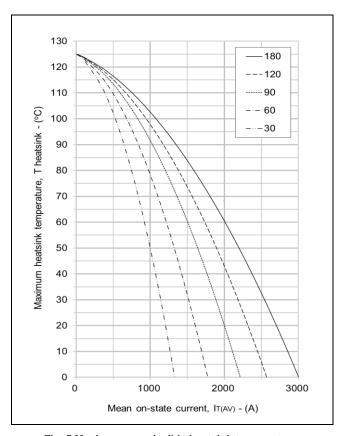


Fig. 5 Maximum permissible heatsink temperature, double side cooled - sine wave

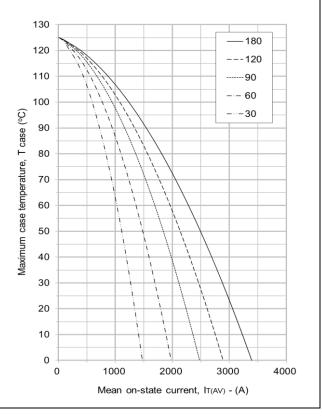


Fig. 4 Maximum permissible case temperature, double side cooled - sine wave

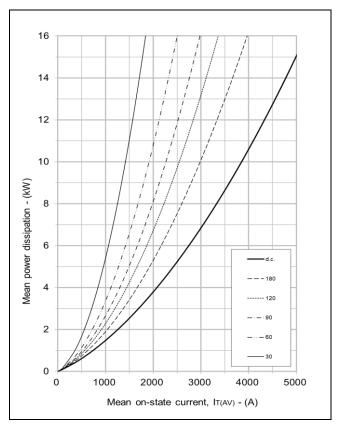


Fig. 6 On-state power dissipation - rectangular wave

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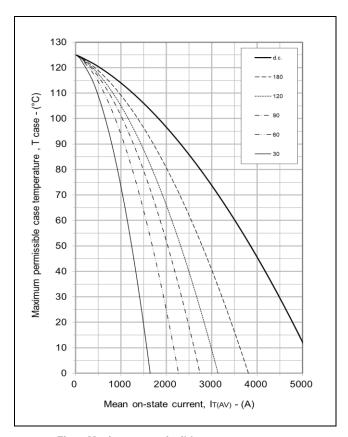
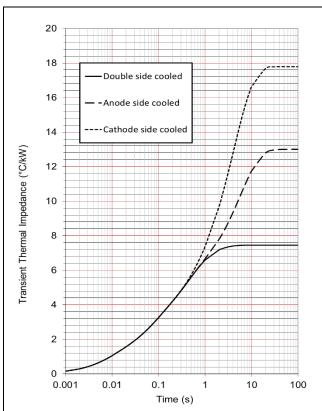


Fig. 7 Maximum permissible case temperature, double side cooled - rectangular wave



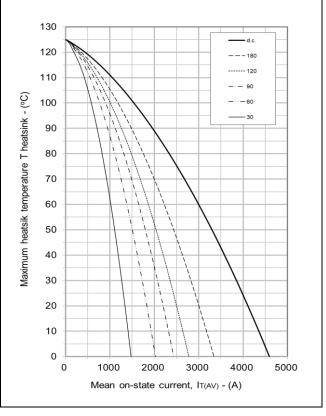


Fig. 8 Maximum permissible heatsink temperature, double side cooled - rectangular wave

		1	2	3	4
Double side	Ri(°C/kW)	0.921	1.830	3.402	1.304
cooled	Ti(s)	0.008	0.058	0.408	1.209
Anode side cooled	Ri(°C/kW)	0.903	1.672	3.010	7.427
	Ti(s)	0.008	0.054	0.314	5.624
Cathode side cooled	Ri(°C/kW)	0.948	2.066	1.688	13.085
	Ti(s)	0.008	0.065	0.389	4.145

$$Z_{th} = \sum_{i=1}^{i=4} R_i \cdot \left(1 - \exp\left(-\frac{T}{T_i}\right)\right)$$

 $\Delta R_{\text{th(j-c)}}$  Conduction

Tables show the increments of thermal resistance R  $_{\text{th}(j-c)}$  when the device operates at conduction angles other than d.c.

	Double side co	Double side cooling				
	ΔZ <sub>th</sub> (	_				
θ°	sine.	rect.				
180	1.34	0.88				
120	1.57	1.30				
90	1.83	1.54				
60	2.08	1.81				
30	2.27	2.11				
45	0.00	0.00				

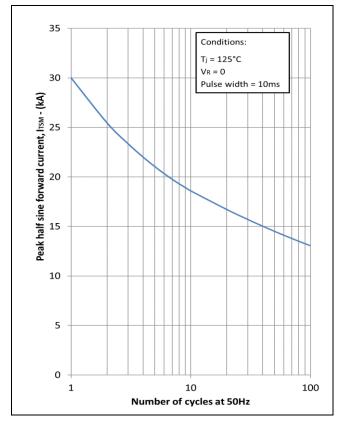
	Anoge Sige	Coolina
		h (Z)
θ°	sine.	rect.
180	1.34	0.88
120	1.57	1.30
90	1.84	1.54
60	2.08	1.81
30	2.28	2.11
45	0.27	0.00

Ca	thode Sided Cooling		
	$\Delta Z_t$	h (Z)	
θ°	sine.	rect.	
180	1.33	0.88	
120	1.57	1 29	
90	183	1.53	
60	2.07	1.80	
30	2.26	2.10	
15	235	2.26	

Fig. 9 Maximum (limit) transient thermal impedance - junction to case (degC/kW)

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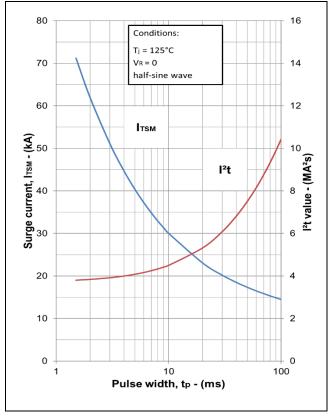


Fig. 10 Multi-cycle surge current

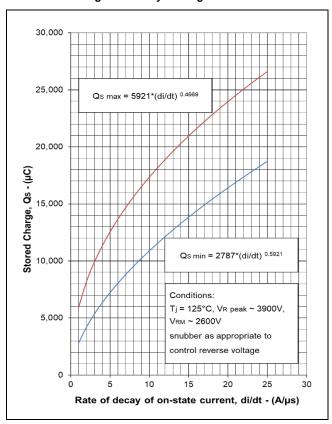


Fig. 12 Stored charge

Fig. 11 Single-cycle surge current

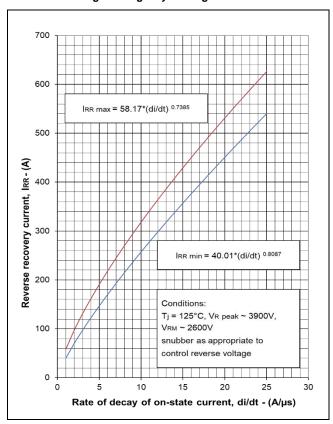


Fig. 13 Reverse recovery current

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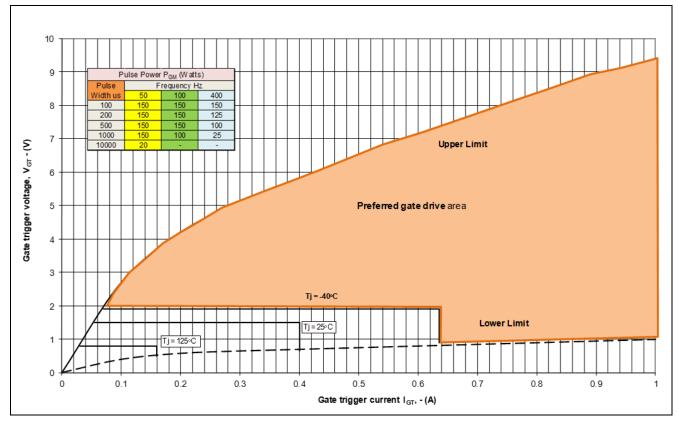


Fig. 14 Gate characteristics

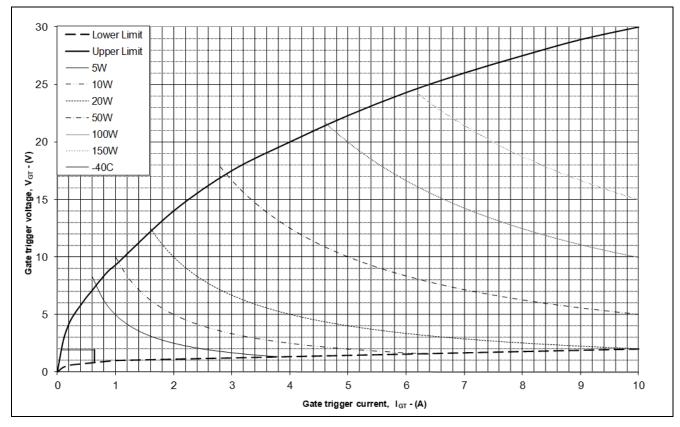


Fig. 15 Gate characteristics

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#### **PACKAGE DETAILS**

For further package information, please contact Customer services.

All dimensions in mm, unless stated otherwise.

DO NOT SCALE

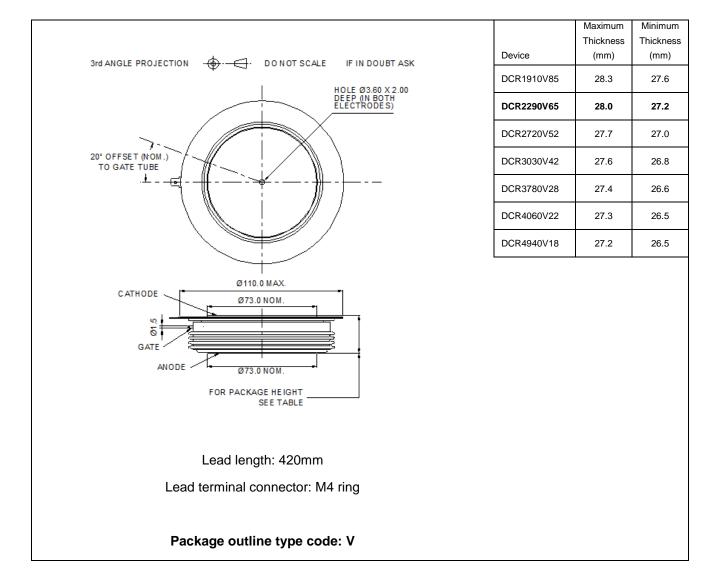


Fig. 16 Package outline

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